

**S/N 10/623,788**

**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant: Leonard Forbes et al.

Examiner: Pamela E. Perkins

Serial No.: 10/623,788

Group Art Unit: 2822

Filed: July 21, 2003

Docket No.: 1303.109US1

Title: STRAINED SEMICONDUCTOR BY FULL WAFER BONDING

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**AMENDMENT AND RESPONSE UNDER 37 CFR § 1.111**

Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

This responds to the Office Action dated on March 29, 2006. Please amend the above-identified patent application as follows.